

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	1	"5325265".PN	USPAT; USOCR	OR	ON	2004/11/19 09:36
L3	1	"5704416".PN.	USPAT; USOCR	OR	ON	2004/11/19 09:36
L5	0	@ad<="20020716" and 'multichip modules' and 'IC' and 'stiffener' with 'polermer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:47
L6	42	@ad<="20020716" and 'PGA' same 'substrate' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:47
L7	6	@ad<="20020716" and 'multichip modules' and 'IC' and 'stiffener' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:47
L8	0	@ad<="20020716" and 'heat pipe' same 'heat spreader' and 'substrate' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:52
L9	50	@ad<="20020716" and 'heat pipe' and 'substrate' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:53
L10	112	@ad<="20020716" and 'MCM' and 'heat sink' and 'substrate' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 11:06
L11	3	@ad<="20020716" and 'MCM' same 'heat sink' same 'substrate' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:56
L12	0	@ad<="20020716" and 'MCM' and 'package substrate' with 'polymer' with 'ceramic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 11:06
L13	6	@ad<="20020716" and 'MCM' and 'package substrate' with 'polymer'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 11:07

L14	3	@ad<="20020716" and 'package substrate' with 'polymer' with 'ceramic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 11:08
S1	2	"20040057214"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/17 17:31
S2	1	@ad<="20020716" and 'multichip modules' and 'IC' and 'PCB' and 'vapor chamber'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/17 17:33
S3	1	"6429513".PN	USPAT; USOCR	OR	ON	2004/11/17 17:32
S4	2	@ad<="20020716" and 'multichip modules' and 'IC' and 'vapor chamber'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:43
S5	14	@ad<="20020716" and 'multichip modules' and 'IC' and 'lid' and 'dissipating'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/17 17:41
S6	5	@ad<="20020716" and 'multichip modules' and 'IC' and 'hollow' same 'heat'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/17 17:41
S7	31	@ad<="20020716" and 'multichip modules' and 'hollow' same 'heat'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/17 17:44
S8	1	"6429513".PN.	USPAT; USOCR	OR	ON	2004/11/17 17:48
S9	1	"6212074".PN.	USPAT; USOCR	OR	ON	2004/11/17 17:48
S10	1	"6166908".PN.	USPAT; USOCR	OR	ON	2004/11/17 17:49
S11	1	"6091603".PN.	USPAT; USOCR	OR	ON	2004/11/17 17:50
S12	81	@ad<="20020716" and 'heat sink' same 'vapor chamber'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/17 17:50
S13	1	"6429513".PN.	USPAT; USOCR	OR	ON	2004/11/18 07:40
S14	1	"5880524".PN.	USPAT; USOCR	OR	ON	2004/11/18 07:40

S15	1	"5915463".PN.	USPAT; USOCR	OR	ON	2004/11/18 07:40
S16	6	@ad<="20020716" and 'MCM' and 'vapor chamber' and 'heat sink'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:56
S17	81	@ad<="20020716" and 'vapor chamber' same 'heat sink'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:24
S18	1	"6237223".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:11
S19	1	"6062302".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:12
S20	1	"5864466".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:12
S21	1	"5704416".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:12
S22	1	"5647430".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:13
S23	1	"6269865".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:14
S24	1	"6269865".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:14
S25	1	"6164368".PN.	USPAT; USOCR	OR	ON	2004/11/18 08:14
S26	1339	@ad<="20020716" and (438/122-123).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:00
S27	647	@ad<="20020716" and (438/125).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:01
S28	115	@ad<="20020716" and (438/55).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:01
S29	1496	@ad<="20020716" and (257/706-707).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:01
S30	1483	@ad<="20020716" and (257/704-705).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:02

S31	719	@ad<="20020716" and (257/675).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:02
S32	874	@ad<="20020716" and (257/717).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:12
S33	1041	@ad<="20020716" and (257/721-722).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:02
S34	1922	@ad<="20020716" and (361/704).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:02
S35	556	@ad<="20020716" and (361/709).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:03
S36	130	@ad<="20020716" and (361/711).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:03
S37	336	@ad<="20020716" and (361/717).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:03
S38	929	@ad<="20020716" and (361/719).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:04
S39	797	@ad<="20020716" and (361/690-691).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:04
S40	1055	@ad<="20020716" and (165/104-33).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:04
S41	848	@ad<="20020716" and (165/104-21).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 09:04

S42	1	"5751062".PN.	USPAT; USOCR	OR	ON	2004/11/18 09:35
S43	1	"5930115".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:06
S44	1	"5880930".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:06
S45	1	"5625227".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:06
S46	1	"5345107".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:06
S47	1	"4612978".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:09
S48	1	"5179500".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:09
S49	1	"5325265".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:09
S50	1	"5704416".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:09
S51	1	"5880524".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:10
S52	1	"5915463".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:10
S53	1	"6085831".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:10
S54	1	"6091603".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:10
S55	1	"5880524".PN.	USPAT; USOCR	OR	ON	2004/11/18 10:11
S56	33	@ad<="20020716" and (257/717).ccls. and 'chamber'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:13
S57	43	@ad<="20020716" and (257/717).ccls. and 'pipe'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:13
S58	67	@ad<="20020716" and 'chamber' same 'heat spreader'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:24
S59	206	@ad<="20020716" and 'pipe' same 'heat spreader'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:25

S60	9	@ad<="20020716" and 'heatpipe' same 'heat spreader'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 10:25
S61	190	@ad<="20020716" and 'heat pipe' same 'heat spreader'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 10:52